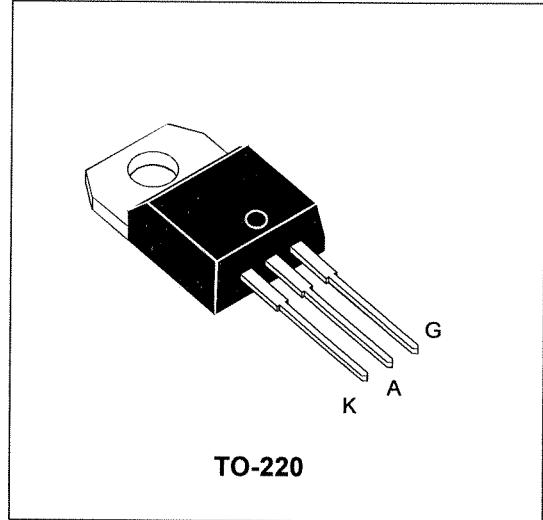


FEATURES

- # ITRMS = 20A
- # IGT < 25mA
- # HIGH SURGE PERFORMANCE
- # Insulation voltage : 2500V RMS
(UL recognized file E81734)

DESCRIPTION

The TXN692 Silicon Controlled Rectifier uses a high performance glass passivated technology. This SCR is suitable for crowbar protection or to drive inductive load.



ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|--------------------|--|---|------------------|
| $I_{T(RMS)}$ | RMS on-state current (180° conduction angle) | Tc = 85 °C 20 | A |
| $I_{T(AV)}$ | Average on-state current (180° conduction angle) | Tc = 85 °C 13 | A |
| I_{TSM} | Non repetitive surge peak on-state current (TJ initial = 25°C) | tp = 8.3 ms tp = 10 ms 260 250 | A |
| I^2t | I^2t value for fusing | tp = 10 ms 310 | A ² s |
| dI/dt | Critical rate of rise of on-state current $I_G = 100$ mA $dI_G/dt = 1A / \mu s$ | 100 | A/ μ s |
| T_{stg} T_j | Storage temperature range Operating junction temperature range | -40+150 -40+125 | °C |
| T_l | Maximum lead temperature for soldering during 10s at 4.5mm from case. | 260 | °C |

| Symbol | Parameter | TYN692 | Unit |
|------------------------|--|--------|------|
| V_{DRM} V_{RRM} | Repetitive peak off-state voltage $T_j = 125^\circ C$ | 800 | V |

THERMAL RESISTANCES

| Symbol | Parameter | Value | Unit |
|-----------------------|-------------------------|-------|------|
| R _{th (j-a)} | Junction to ambient | 60 | °C/W |
| R _{th (j-c)} | Junction to case for DC | 2.5 | °C/W |

GATE CHARACTERISTICS

$$P_{G(AV)} = 1 \text{ W} \quad P_{GM} = 10 \text{ W} (\text{tp} = 20\mu\text{s}) \quad I_{FGM} = 4 \text{ A} (\text{tp} = 20\mu\text{s}) \quad V_{RGM} = 5 \text{ V}$$

ELECTRICAL CHARACTERISTICS

| Symbol | Test conditions | | | | Value | Unit |
|------------------|--|--------------|------------------------|-----|-------|------|
| I _{GT} | V _D = 12V (DC) | RL = 33 Ohm | T _j = 25°C | MAX | 25 | mA |
| V _{GT} | V _D = 12V (DC) | RL = 33 Ohm | T _j = 25°C | MAX | 1.3 | V |
| V _{GD} | V _D = V _{DRM} | RL = 3.3kOhm | T _j = 125°C | MIN | 0.2 | V |
| I _H | I _T = 100mA | Gate open | T _j = 25°C | MAX | 40 | mA |
| I _L | I _G = 1.2 x I _{GT} | | T _j = 25°C | MAX | 90 | mA |
| V _{TM} | I _{TM} = 50A | tp = 380μs | T _j = 25°C | MAX | 1.4 | V |
| I _{DRM} | V _D = V _{DRM} | | T _j = 25°C | MAX | 10 | μA |
| I _{RRM} | V _R = V _{RRM} | | T _j = 125°C | MAX | 2 | mA |
| dV/dt | V _D = 67% V _{DRM} | Gate open | T _j = 125°C | MIN | 500 | V/μs |